Declaration and Power of Attorney For Patent Application English Language Declaration

	=ngnsn Ea	inguage Declaration	
As a below name	d inventor, I hereby declar	e that:	\sim
My residence, pos	st office address and citize	enship are as stated below n	ext to my name,
and for which a paul of the specification of the sp	atent is sought on the inventor (if plural flames are if atent is sought on the inventor (if which is attached hereto) 08 February 1999	T International Application N	Natter which is claimed V DATA TRANSMITTING NSCEIVING SYSTEM, AND checked: MEDIU
I hereby state that specification, inclu	I have reviewed and unde ding the claims, as amend	erstand the contents of the a led by any amendment refer	red to above.
I acknowledge the CFR § 1.56.	duty to disclose informati	on which is material to pater	ntability as defined in 37
which designated a identified below by	at least one country other	er 35 U.S.C. §119(a)-(d) or cate, or § 365(a) of any PC r than the United States, lis oreign application for patent g date before that of the app	T International application ited below and have als
Prior Foreign Applic H10-031,847	ation(s) JAPAN	13 February, 1998	Priority Not Claimed
Number) H10-151,586	(Country) JAPAN	(Day/Month/Year Filed) 1 June, 1998	
Number)	(Country)	(Day/Month/Year Filed)	
110-224,825	JAPAN	7 August, 1998	<u></u>
Number)	(Country)	(Day/Month/Year Filed)	
hereby claim the b sted below.	enefit under 35 U.S.C. &	119(e) of any United States	provisional application(s)
Application Number).	(Filing Date)		
Application Number	(F3)		

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States of PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

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(Application Number)	(Filing Date)	(Status - patented, pending, abando	ned) -
(Application Number)	(Filing Date)	(Status - patented, pending, abando	ned)
BOWER OF AT	TORNEY, A.			*
agent(s) to pros	CUINEY: AS	a named inventor,	I hereby appoint the following a	ttorney(s) and/o
connected there	ecate this app	nication and transa	ct all business in the Patent and I	rademark Office
	,	_		1
Paul F. Prestia Allan Ratner	Reg.No. 23,031 Reg.No. 19,717	Lawrence E. Ashery Robert L. Anderson	Reg.No. 34,515 Mark J. Marcelli	Reg.No. 36,593
Andrew L. Ney	Reg.No. 20,300	Christopher R. Lewis	Reg.No. 25,771 / Christopher J. Dervishia Reg.No. 36,201	an Reg.No. 42,480
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			7	
I hereby declare	that all sta	atements made he	rein of my own knowledge are	true and that all
statements mad	le on informa	ition and helief ar	e believed to be true; and fun	true and that all
statements were	a mada with	the knowledge th	e believed to be true; and fun	ther that these
made ere evel-b	s made with	ine knowledge in	at willful false statements a	nd the like so
made are punisr	nable by fine	or imprisonment,	or both, under Section 1001 of	Title 18 of the
United States C	ode and that	such willful false	statements may jeopardize the	validity of the
application or an	y patent issue	dythereon.		·
Full name of sole or fi	rst inventor (given	name family name) Ta	kuya NISHIMURA	
				
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